



RS1MWF

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I ₀ (A)	V _F Max (V)	I _R Max (μA)	
1,000	1	1.3	5	

Description and Applications

The RS1MWF is a rectifier packaged in the small form factor, low profile SOD123F (standard). Providing fast recovery time for high efficiency, low reverse leakage current and high surge current capability, this device is ideal for use in general rectification applications such as:

- Switching Mode Power Supplies
- DC-DC Converters
- AC-DC Adaptors/Chargers
- Mobile Devices



Top View

1.0A SURFACE MOUNT FAST RECOVERY RECTIFIER

Features and Benefits

- Glass Passivated Die Construction
- Small Form Factor, Low Profile
- Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- Low Reverse Leakage Current
- High Reverse Breakdown Voltage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.018 grams (Approximate)

SOD123F (Standard)



Bottom View

1 0 2 CATHODE ANODE

Schematic View

Ordering Information (Note 4)

	Part Number	Compliance	Case	Packaging				
	RS1MWF-7	Commercial	SOD123F (Standard)	3,000/Tape & Reel				
Notes:	lotes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.							

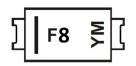
 2. See https://www.lodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

SOD123F (Standard)



F8 = Product Type Marking CodeYM = Date Code MarkingY = Year (ex.: G = 2019)M = Month (ex: 9 = September)

Date Code Key

Year	1	2014	2015	20	016	2017	201	8	2019	2020)	2021
Code		В	С		D	E	F		G	Н		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	1	5	6	7	8	0	0	N	П



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}		
Working Peak Reverse Voltage	V _{RWM}	1,000	V
DC Blocking Voltage	V _{RM}		
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current (@ T _T = +88°C)	lo	1.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	30	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	R _{θJC}	10	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{0JA}	65	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	1,000	—	_	V	I _R = 5μA
	VF	_	1.0	1.3	V	I _F = 1A, T _J = +25°C
Forward Voltage Drop			0.9	1.2		I _F = 1A, T _J = +125°C
			1.1	—		$I_F = 2A, T_J = +25^{\circ}C$
			1.0	—		I _F = 2A, T _J = +125°C
Laskage Current (Note 6)	I _R	_	0.2	5.0	μA	$V_R = 1,000V, T_J = +25^{\circ}C$
Leakage Current (Note 6)			24	200		V _R = 1,000V, T _J = +125°C
Reverse Recovery Time	t _{RR}	—	240	500	ns	$I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A$
Total Capacitance	CT	—	8	_	pF	$V_R = 4.0V_{DC}$, f = 1MHz

 Notes:
 5. Device mounted on FR-4 substrate, 1.0" x 1.0", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad.

 6. Short duration pulse test used to minimize self-heating effect.



RS1MWF

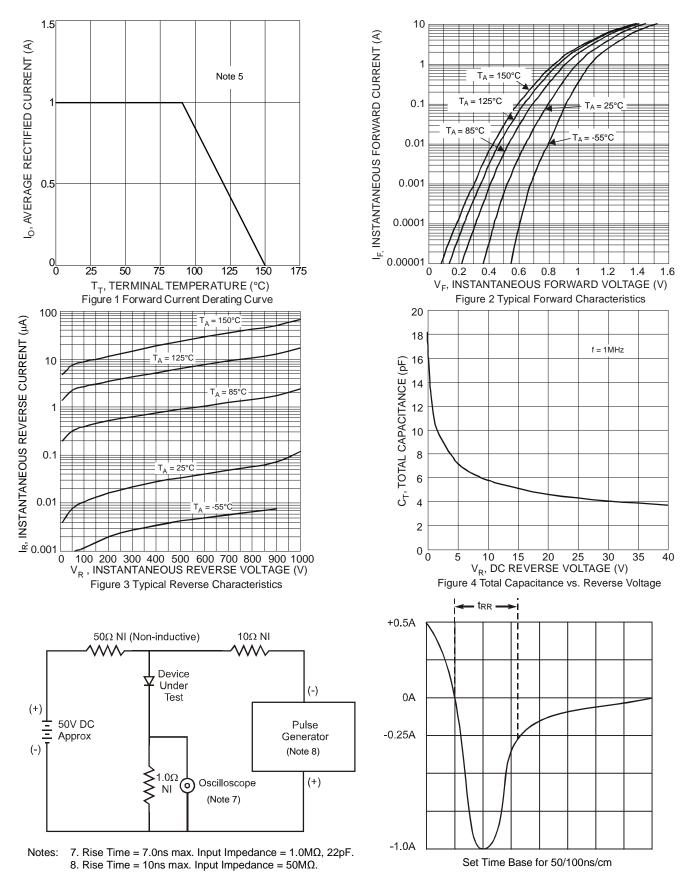


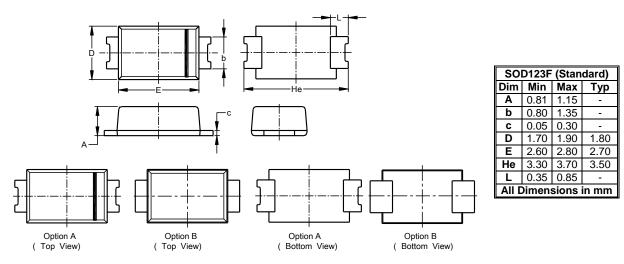
Figure 5 Reverse Recovery Time Characteristic and Test Circuit



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

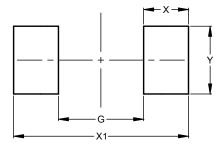
SOD123F (Standard)



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123F (Standard)



Dimensions	Value (in mm)
G	1.90
Х	1.00
X1	3.90
Y	1.50



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